CM1263-06DE

Low Capacitance ESD Protection for High-Speed Serial Interfaces

Features

- 6 Channels of ESD Protection
- 1 pF Loading Capacitance per Channel Typical
- ±8 kV ESD Protection (IEC 61000–4–2, Contact Discharge)
- ±15 kV ESD Protection (IEC 61000–4–2, Air Discharge)
- These Devices are Pb-Free and are RoHS Compliant

Applications

- LCD and Camera Data Lines in Wireless Handsets that Use High-Speed Serial Interfaces such as MDDI, MIPI, MVI and MPL
- I/O Port Protection for Mobile Handsets, Notebook Computers, PDAs, etc.
- Wireless Handsets
- Handheld PCs/PDAs
- LCD and Camera Modules



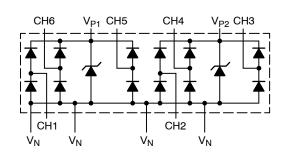
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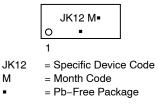


UDFN12 DE SUFFIX CASE 517BD

BLOCK DIAGRAM



MARKING DIAGRAM



(*Note: Microdot may be in either location)

*Date Code orientation and/or position may vary depending upon manufacturing location.

ORDERING INFORMATION

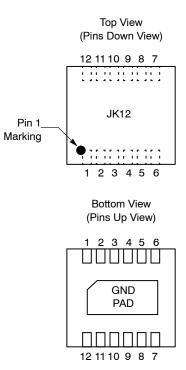
| Device | Package | Shipping [†] |
|-------------|-----------|-----------------------|
| CM1263-06DE | UDFN | 3000/Tape & Reel |
| | (Pb-Free) | |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

Table 1. PIN DESCRIPTIONS

| Pin | Description | | |
|------|-------------------------------------|--|--|
| 1 | V _N * | | |
| 2 | (CH1) ESD Channel #1 | | |
| 3 | V _N * | | |
| 4 | V _N * | | |
| 5 | (CH2) ESD Channel #2 | | |
| 6 | V _N * | | |
| 7 | (CH3) ESD Channel #3 | | |
| 8 | V_{P2} for Channels 2, 3, and 4 | | |
| 9 | (CH4) ESD Channel #4 | | |
| 10 | (CH5) ESD Channel #5 | | |
| 11 | V_{P1} for Channels1, 5, and 6 | | |
| 12 | (CH6) ESD Channel #6 | | |
| DAP* | Backside, GND Pad, V _N * | | |

PACKAGE / PINOUT DIAGRAM



12-Lead UDFN Package

CM1263-06DE

SPECIFICATIONS

Table 2. ABSOLUTE MAXIMUM RATINGS

| Parameter | Rating | Units |
|---|--|-------|
| Operating Supply Voltage (V _P - V _N) | 6.0 | V |
| Operating Temperature Range | -40 to +85 | °C |
| Storage Temperature Range | -65 to +150 | °C |
| DC Voltage at any channel input | (V _N – 0.5) to (V _P + 0.5) | V |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

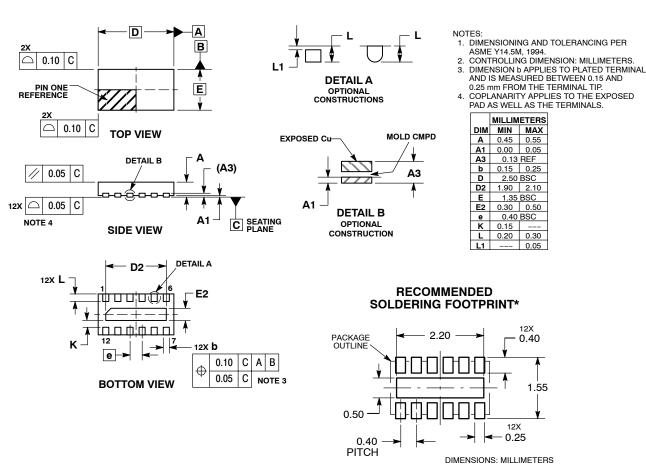
Table 3. ELECTRICAL OPERATING CHARACTERISTICS (Note 1)

| Symbol | Parameter | Conditions | Min | Тур | Max | Units |
|---|---|--|--------------|---------------|--------------|-------|
| VP | Operating Supply Voltage (V _P -V _N) | | | 3.3 | 5.5 | V |
| Ι _Ρ | Operating Supply Current | V_P = 3.3 V, V_N = 0 V (per V _P pin) | | | 8.0 | μΑ |
| V _F | Diode Forward Voltage Top Diode Bottom Diode | $T_A = 25^{\circ}C, I_F = 8 \text{ mA}, V_P = 3.3 \text{ V}, V_N = 0 \text{ V}$ | 0.60 0.60 | 0.80 0.80 | 0.95 0.95 | V |
| I _{LEAK} Channel Leakage Current | Channel Leakage Current | $T_A = 25^{\circ}C; V_P = 3.3 V, V_N = 0 V$ (Channel 1) | | | 250 | nA |
| | | V _P = 3.3 V, V _N = 0 V (Channels 1–6) | | | 1000 | nA |
| I _R | Reverse (Leakage Current) | V_P = floating; V_N = 0 V (per channel) | | | 1000 | nA |
| C _{IN} | Channel Input Capacitance | At 1 MHz, V _P = 3.3 V, V _N = 0 V, V _{IN} = 0 V | | 0.88 | 1.2 | pF |
| ΔC_{IN} | Channel Input Capacitance Matching | At 1 MHz, V_P = 3.3 V, V_N = 0 V, V_{IN} = 0 V | | 0.02 | | pF |
| C _{MUTUAL} | Mutual Capacitance between signal pin and adjacent signal pin | At 1 MHz, V_P = 3.3 V, V_N = 0 V, V_{IN} = 0 V | | 0.11 | | pF |
| V _{ESD} | ESD Protection Peak Discharge Voltage at any channel input, in system a) Contact discharge per | $T_A = 25^{\circ}C$ (Notes 2 and 3) | ±8 | | | kV |
| b) Air dis | IEC 61000-4-2 standard b) Air discharge per IEC 61000-4-2 standard | | ±15 | | | |
| V _{CL} | Channel Clamp Voltage Positive Transients Negative Transients | $T_A = 25^{\circ}C$, $I_{PP} = 1$ A, $t_P = 8/20 \ \mu S$ (Note 3) | | +9.96 -1.6 | | V |
| R _{DYN} | Dynamic Resistance Positive Transients Negative Transients | $T_A = 25^{\circ}C$, $I_{PP} = 1$ A, $t_P = 8/20 \ \mu S$ Any I/O pin to Ground (Note 3) | | 0.96 0.5 | | Ω |

All parameters specified at T_A = -40°C to +85°C unless otherwise noted.
Standard IEC 61000-4-2 with C_{Discharge} = 150 pF, R_{Discharge} = 330 Ω, V_P = 3.3 V, V_N grounded.
These measurements performed with no external capacitor on V_P (V_P floating).

PACKAGE DIMENSIONS

UDFN12, 2.5x1.35, 0.4P CASE 517BD **ISSUE O**



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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